

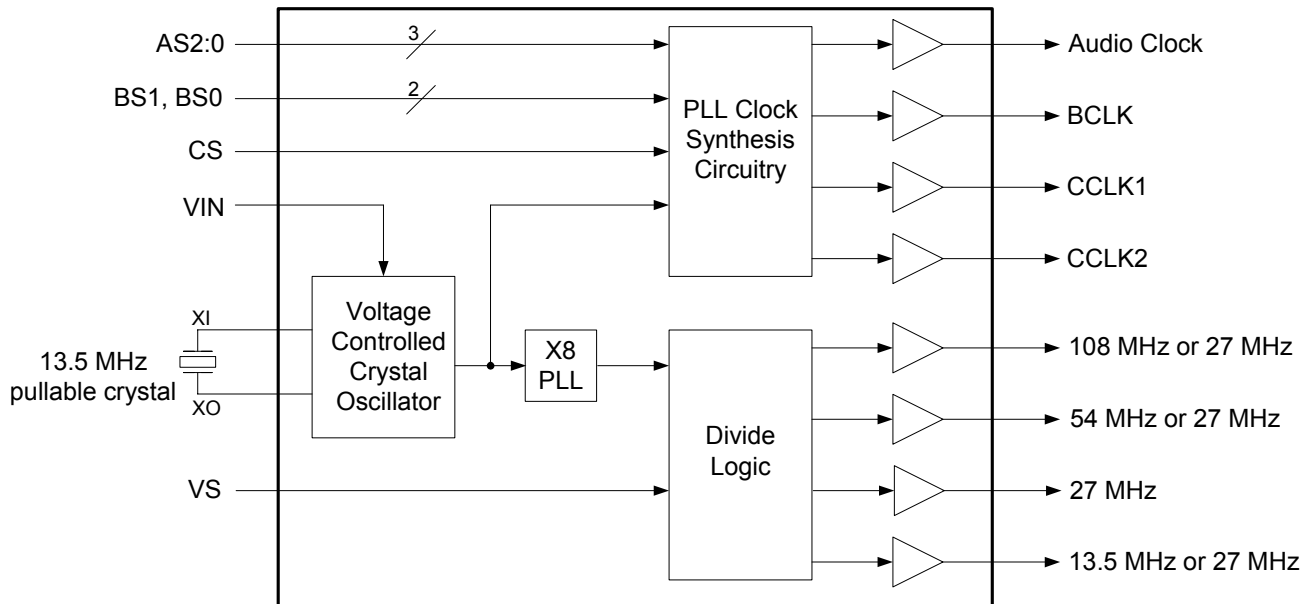
## Description

The MK3771-17 is a low cost, low jitter, high-performance VCXO and clock synthesizer designed for set-top boxes and HDTV receivers. The on-chip Voltage Controlled Crystal Oscillator accepts a 0 to 3.3 V input voltage to cause the output clocks to vary by  $\pm 100$  ppm. Using IDT's patented VCXO and analog Phase-Locked Loop (PLL) techniques, the device uses an inexpensive 13.5 MHz crystal input to produce multiple output clocks including selectable BCLK, a selectable audio clock, two communications clocks, a 13.5 MHz clock, and three 27 MHz clocks. All clocks are frequency locked to the 27 MHz output (and to each other) with zero ppm error, so any output can be used as the VCXO output.

## Features

- Packaged in 28-pin SSOP
- Pb (lead) free package
- HDTV frequencies of 74.25 and 74.175824 MHz
- On-chip patented VCXO with pull range of 200 ppm (minimum)
- VCXO tuning voltage of 0 to 3.3 V
- Supports Ethernet with 20 and 25 MHz clocks
- Modem clocks of 11.0592 and 24.576 MHz option
- Audio clocks support 32 kHz, 44.1 kHz, 48 kHz and 96 kHz sampling rates
- Zero ppm synthesis error in all clocks (all exactly track 27MHz VCXO)
- Uses an inexpensive 13.5 MHz crystal
- Full CMOS output swings with 12 mA output drive capability at TTL levels
- Advanced, low power, sub-micron CMOS process
- 3.3 V  $\pm 5\%$  operating supply

## Block Diagram



## Pin Assignment

BS0	<input type="checkbox"/>	1	28	<input type="checkbox"/>	AS1
X2	<input type="checkbox"/>	2	27	<input type="checkbox"/>	AS0
X1	<input type="checkbox"/>	3	26	<input type="checkbox"/>	VCLK2
VDD	<input type="checkbox"/>	4	25	<input type="checkbox"/>	VCLK1
VDD	<input type="checkbox"/>	5	24	<input type="checkbox"/>	GND
VIN	<input type="checkbox"/>	6	23	<input type="checkbox"/>	VCLK4
VDD	<input type="checkbox"/>	7	22	<input type="checkbox"/>	VDD
VDD	<input type="checkbox"/>	8	21	<input type="checkbox"/>	AS2
CS	<input type="checkbox"/>	9	20	<input type="checkbox"/>	GND
GND	<input type="checkbox"/>	10	19	<input type="checkbox"/>	GND
GND	<input type="checkbox"/>	11	18	<input type="checkbox"/>	VCLK3
BCLK	<input type="checkbox"/>	12	17	<input type="checkbox"/>	CCLK1
VS	<input type="checkbox"/>	13	16	<input type="checkbox"/>	BS1
ACLK	<input type="checkbox"/>	14	15	<input type="checkbox"/>	CCLK2

## Audio Clocks (MHz)

AS2	AS1	AS0	ACLK
0	0	0	8.192
0	0	1	11.2896
0	1	0	12.288
0	1	1	16.9344
1	0	0	16.384
1	0	1	22.5792
1	1	0	18.432
1	1	1	24.576

## B and C Clocks (MHz)

BS1	BS0	CS	BCLK	CCLK1	CCLK2
0	0	0	74.175	20	25
0	0	1	74.175	11.0592	24.576
0	1	0	74.25	20	25
0	1	1	74.25	11.0592	24.576
M	0	0	5.06	20	25
M	0	1	5.06	11.0592	24.576
M	1	0	10.12	20	25
M	1	1	10.12	11.0592	24.576
1	0	0	48	20	25
1	0	M	48	7.3728	24
1	0	1	48	11.0592	24.576
1	1	0	14.318	20	25
1	1	M	14.318	7.3728	28.636
1	1	1	14.318	11.0592	24.576

## VCXO Clocks (MHz)

VS	VCLK1	VCLK2	VCLK3	VCLK4
0	27	27	27	108
M	27	54	13.5	108
1	27	27	27	27

## Pin Descriptions

Pin Number	Pin Name	Pin Type	Pin Description
1	BS0	I	B clock select 0.
2	X2	XO	Crystal connection. Connect to a pullable 13.5 MHz crystal.
3	X1	XI	Crystal connection. Connect to a pullable 13.5 MHz crystal.
4, 5, 7, 8, 22	VDD	P	Connect to +3.3 V.
6	VIN	I	Analog control voltage for VCXO. Pulls outputs $\pm 100$ ppm by varying from 0 to 3.3 V.
9	CS	TI	Communications Clock Select. Selects CCLK 1 and 2 per table above. Internal pull-up.
10, 11, 19, 20, 24	GND	P	Connect to ground.
12	BCLK	O	B clock output. Determined by status of AS2:0 per table above.
13	VS	TI	VCXO Clock Select. Selects frequencies on VCLK1-VCLK4 per table above.
14	ACLK	O	Audio Clock Output. Determined by status of AS2:0 per table above.
15	CCLK2	O	Communications Clock Output 2. Determined by status of CS per table above.
16	BS1	TI	B Clock Select 1. Selects BCLK frequency. See table above.
17	CCLK1	O	Communications Clock Output 1. Determined by status of CS per table above.
18	VCLK3	O	VCXO Clock output 3. Can be either 27 or 13.5 MHz per table above.
21	AS2	I	Audio Clock Select pin 2. Selects Audio clock on pin 14 per table above. Internal pull-up.
23	VCLK4	O	VCXO Clock output 4. Can be either 27 or 108 MHz per table above.
25	VCLK1	O	VCXO Clock output 1. Always 27 MHz.
26	VCLK2	O	VCXO Clock output 2. Can be either 27 or 54 MHz per table above.
27	AS0	I	Audio Clock Select pin 0. Selects Audio clock on pin 14 per table above. Internal pull-up.
28	AS1	I	Audio Clock Select pin 1. Selects Audio clock on pin 14 per table above. Internal pull-up.

### KEY:

I = Input

TI = Tri-level

O = Output

P = Power supply connection

XI, XO= Crystal connections

## External Component Selection

The MK3771-17 requires a minimum number of external components for proper operation.

### Decoupling Capacitors

Decoupling capacitors of 0.01μF should be connected between VDD and GND on pins 3 and 6, and on pins 13 and 14, as close to the MK3771-17 as possible. For optimum device performance, the decoupling capacitors should be mounted on the component side of the PCB. Avoid the use of vias in the decoupling circuit.

### Series Termination Resistor

When the PCB traces between the clock outputs and the loads are over 1 inch, series termination should be used. To series terminate a 50Ω trace (a commonly used trace impedance) place a 33Ω resistor in series with the clock line, as close to the clock output pin as possible. The nominal impedance of the clock output is 20Ω

### Quartz Crystal

The MK3771-17 VCXO function consists of the external crystal and the integrated VCXO oscillator circuit. To assure the best system performance (frequency pull range) and reliability, a crystal device with the recommended parameters must be used, and the layout guidelines discussed in the following section must be followed.

The frequency of oscillation of a quartz crystal is determined by its “cut” and by the load capacitors connected to it. The MK3771-17 incorporates on-chip variable load capacitors that “pull” (change) the frequency of the crystal. The crystal specified for use with the MK3771-17 is designed to have zero frequency error when the total of on-chip + stray capacitance is 14 pF.

The external crystal must be connected as close to the chip as possible and should be on the same side of the PCB as the MK3771-17. There should be no vias between the crystal pins and the X1 and X2 device pins. There should be no signal traces underneath or close to the crystal.

Please see application note MAN05 for recommended crystal parameters and suppliers.

### Crystal Tuning Load Capacitors

The crystal traces should include pads for small fixed

capacitors, one between X1 and ground, and another between X2 and ground. Stuffing of these capacitors on the PCB is optional. The need for these capacitors is determined at system prototype evaluation, and is influenced by the particular crystal used (manufacture and frequency) and by PCB layout. The typical required capacitor value is 1 to 4 pF.

To determine the need for and value of the crystal adjustment capacitors, you will need a PC board of your final layout, a frequency counter capable of about 1 ppm resolution and accuracy, two power supplies, and some samples of the crystals which you plan to use in production, along with measured initial accuracy for each crystal at the specified crystal load capacitance, CL.

To determine the value of the crystal capacitors:

1. Connect VDD of the MK3771-17 to 3.3 V. Connect pin 4 of the MK3771-17 to the second power supply. Adjust the voltage on pin 4 to 0V. Measure and record the frequency of the CLK output.
2. Adjust the voltage on pin 4 to 3.3 V. Measure and record the frequency of the same output.

To calculate the centering error:

$$\text{Error} = 10^6 \times \left[ \frac{(f_{3.3V} - f_{\text{target}}) + (f_{0V} - f_{\text{target}})}{f_{\text{target}}} \right] - \text{error}_{\text{xtal}}$$

Where:

$f_{\text{target}}$  = nominal crystal frequency

$\text{error}_{\text{xtal}}$  = actual initial accuracy (in ppm) of the crystal being measured

If the centering error is less than ±25 ppm, no adjustment is needed. If the centering error is more than 25ppm negative, the PC board has excessive stray capacitance and a new PCB layout should be considered to reduce stray capacitance. (Alternately, the crystal may be re-specified to a higher load capacitance. Contact IDT for details.) If the centering error is more than 25ppm positive, add identical fixed centering capacitors from each crystal pin to ground. The value for each of these caps (in pF) is given by:

External Capacitor =

$2 \times (\text{centering error}) / (\text{trim sensitivity})$

Trim sensitivity is a parameter which can be supplied by your

crystal vendor. If you do not know the value, assume it is 30 ppm/pF. After any changes, repeat the measurement to verify that the remaining error is acceptably low (typically less than  $\pm 25$  ppm).

## Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the MK3771-17. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Item	Rating
Supply Voltage, VDD	7 V
All Inputs and Outputs	-0.5 V to VDD+0.5 V
Ambient Operating Temperature	0 to +70° C
Storage Temperature	-65 to +150° C
Junction Temperature	125° C
Soldering Temperature	260° C

## Recommended Operation Conditions

Parameter	Min.	Typ.	Max.	Units
Ambient Operating Temperature	0		+70	°C
Power Supply Voltage (measured in respect to GND)	+3.15	+3.3	+3.45	V

## DC Electrical Characteristics

Unless stated otherwise,  $V_{DD} = 3.3\text{ V} \pm 5\%$ , Ambient Temperature 0 to  $+70^{\circ}\text{C}$

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Operating Voltage	VDD		3.15	3.3	3.45	V
Input High Voltage	$V_{IH}$	Except TI pins	2			V
Input Low Voltage	$V_{IL}$	Except TI pins			0.8	V
Input High Voltage	$V_{IH}$	All TI pins	VDD-0.5			V
Input Low Voltage	$V_{IL}$	All TI pins			0.5	V
Output High Voltage	$V_{OH}$	$I_{OH} = -12\text{ mA}$	2.4			V
Output Low Voltage	$V_{OL}$	$I_{OH} = 12\text{ mA}$			0.4	V
Output High Voltage	$V_{OH}$	CMOS level, $I_{OH} = -8\text{ mA}$	VDD-0.4			V
Operating Supply Current	IDD	No load, Note 1		28		mA
Power Down Mode Supply Current				15		$\mu\text{A}$
Short Circuit Current		Each output		$\pm 50$		mA
Input Capacitance	$C_{IN}$			5		pF
Frequency Synthesis Error		All clocks			0	ppm
VIN, VCXO Control Voltage			0		3.3	V

## AC Electrical Characteristics

Unless stated otherwise,  $V_{DD} = 3.3\text{ V} \pm 5\%$ , Ambient Temperature 0 to  $+70^{\circ}\text{C}$

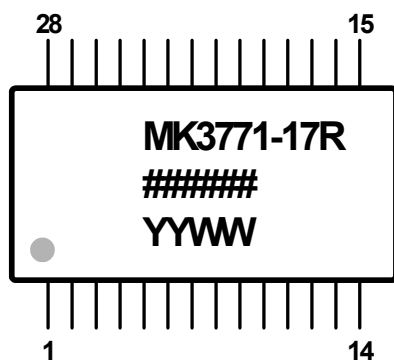
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Input Frequency	$F_{IN}$			13.50000		MHz
Output Clock Rise Time	$t_{OR}$	0.8 V to 2.0 V			1.5	ns
Output Clock Fall Time	$t_{OF}$	2.0 V to 0.8 V			1.5	ns
Output Clock Duty Cycle	$t_{OD}$	At VDD/2	40		60	%
Maximum Absolute Jitter, short term				$\pm 250$		ps
VCXO Gain		$V_{IN} = V_{DD}/2 \pm 1\text{ V}$		100		ppm/V
Crystal Pullability		$0\text{ V} \leq V_{IN} \leq 3.3\text{ V}$ , Note 2	$\pm 100$			ppm

- Notes: 1. With all clocks at highest MHz.  
2. With a pullable crystal that conforms to IDT's specifications.

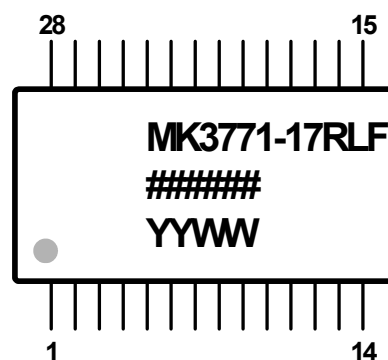
## Thermal Characteristics

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Thermal Resistance Junction to Ambient	$\theta_{JA}$	Still air		100		$^{\circ}\text{C/W}$
	$\theta_{JA}$	1 m/s air flow		80		$^{\circ}\text{C/W}$
	$\theta_{JA}$	3 m/s air flow		67		$^{\circ}\text{C/W}$
Thermal Resistance Junction to Case	$\theta_{JC}$			60		$^{\circ}\text{C/W}$

## Marking Diagram



## Marking Diagram (Pb free)

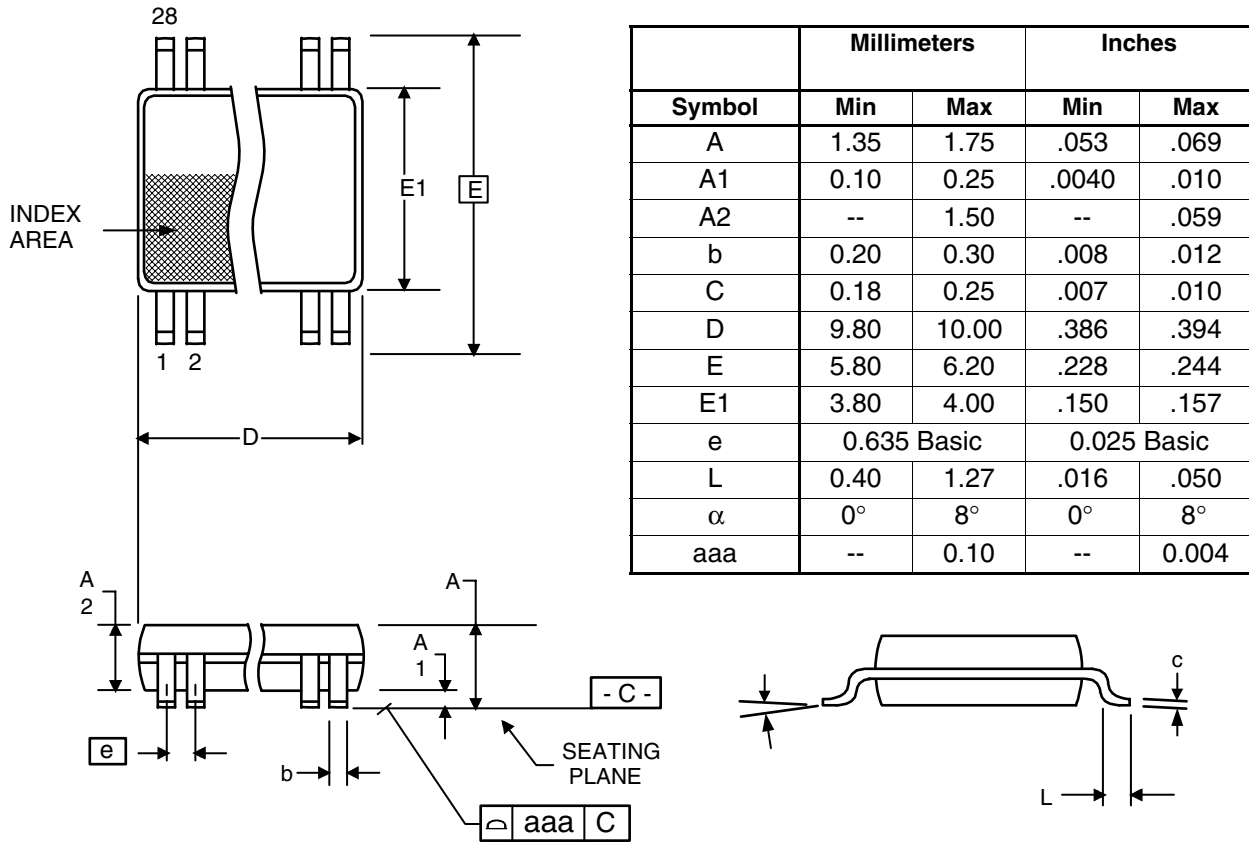


### Notes:

1. ##### is the lot code.
2. YYWW is the last two digits of the year, and the week number that the part was assembled.
3. "LF" designates Pb free packaging.

## Package Outline and Package Dimensions (28-pin SSOP, 150 mil Body, 0.025 mm Pitch)

Package dimensions are kept current with JEDEC Publication No. 95, MO-153



## Ordering Information

Part / Order Number	Marking	Shipping Packaging	Package	Temperature
MK3771-17RLF	MK3771-17RLF	Tubes	28-pin SSOP	0 to +70° C
MK3771-17RLFTR	MK3771-17RLF	Tape and Reel	28-pin SSOP	0 to +70° C

“LF” denotes Pb (lead) free package.

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